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- 3-State Bus-Driving Inverting Outputs
- Buffered Control Inputs
- Package Options Incude Plastic Small-Outline Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs

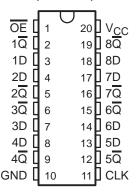
description

These 8-bit flip-flops feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

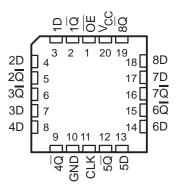
The eight flip-flops of the 'F534A are edge-triggered D-type flip-flops. On the positive transition of the clock, the \overline{Q} outputs are set to the complement of the logic states that were set up at the data (D) inputs. The 'F534A is equivalent to the 'F374 except for having inverted outputs.

A buffered output enable (\overline{OE}) control input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components.

SN54F534A . . . J PACKAGE SN74F534A . . . DW OR N PACKAGE (TOP VIEW)



SN54F534A . . . FK PACKAGE (TOP VIEW)



The output enable (\overline{OE}) does not affect the internal operations of the flip-flops. Old data can be retained or new data can be entered while the outputs are off.

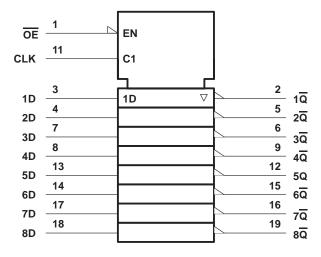
The SN54F534A is characterized for operation over the full military temperature range of -55° C to 125° C. The SN74F534A is characterized for operation from 0° C to 70° C.

FUNCTION TABLE (each flip-flop)

	INPUTS	OUTPUT	
OE	CLK	D	Q
L	1	Н	L
L	\uparrow	L	Н
L	L	Χ	\overline{Q}_0
Н	Χ	Χ	Z

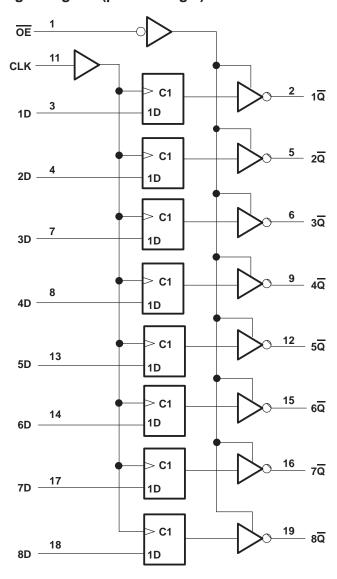
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logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V _{CC}		0.5 V to 7 V
Input voltage range (see Note 1)		1.2 V to 7 V
Input current		±20 mA
Voltage range applied to any output in t	the disabled or power-off state	
Voltage range applied to any output in t	he high state	0.5 V to V _{CC}
Current into any output in the low state:	SN54F534A	40 mA
	SN74F534A	48 mA
Operating free-air temperature range:	SN54F534A	–55°C to 125°C
	SN74F534A	0°C to 70°C
Storage temperature range		–65°C to 150°C

^{\$\}frac{1}{2}\$ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input-voltage ratings may be exceeded provided the input-current ratings are observed.



recommended operating conditions

			SN54F534A			SN74F534A		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
V _{IL}	Low-level input voltage			0.8			0.8	V
ΙΙΚ	Input clamp current			- 18			- 18	mA
IOH	High-level output current			-3			-3	mA
lOL	Low-level output current			20			24	mA
TA	Operating free-air temperature	- 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CONDITIONS		SI	SN54F534A			SN74F534A			
PARAMETER			MIN	TYP†	MAX	MIN	TYP [†]	MAX	UNIT	
VIK	$V_{CC} = 4.5 \text{ V},$	$I_{I} = -18 \text{ mA}$			- 1.2			- 1.2	V	
	V _{CC} = 4.5 V	I _{OH} = – 1 mA	2.5	3.4		2.5	3.4			
Voн	VCC = 4.5 V	$I_{OH} = -3 \text{ mA}$	2.4	3.3		2.4	3.3		V	
	$V_{CC} = 4.75 \text{ V},$	$I_{OH} = -1 \text{ mA to } -3 \text{ mA}$				2.7				
Va	V _{CC} = 4.5 V	I _{OL} = 20 mA		0.3	0.5				V	
VOL		I _{OL} = 24 mA					0.35	0.5		
lozh	$V_{CC} = 5.5 \text{ V},$	V _O = 2.7 V			50			50	μΑ	
lozL	$V_{CC} = 5.5 \text{ V},$	V _O = 0.5 V			-50			-50	μΑ	
lį	$V_{CC} = 5.5 \text{ V},$	V _I = 7 V			0.1			0.1	mA	
lін	$V_{CC} = 5.5 \text{ V},$	V _I = 2.7 V			20			20	μΑ	
I _{IL}	$V_{CC} = 5.5 \text{ V},$	V _I = 0.5 V			- 0.6			- 0.6	mA	
los [‡]	$V_{CC} = 5.5 \text{ V},$	V _O = 0	- 60		- 150	- 60		- 150	mA	
Iccz	$V_{CC} = 5.5 \text{ V},$	See Note 2		55	86		55	86	mA	

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

timing requirements

				V _{CC} = 5 V, T _A = 25°C		V _{CC} = 4.5 V to 5.5 V, T _A = MIN to MAX§				
				34A	SN54F534A		SN74F534A		UNIT	
					MIN	MAX	MIN	MAX		
fclock	clock Clock frequency		0	100	0	60	0	70	MHz	
	Pulse duration	CLK high	7		7		7			
t _W	Pulse duration	CLK low	6		6		6		ns	
	Setup time before CLK↑	Data high	2		2.5		2			
t _{su}	Setup time before CENT	Data low	2		2.5		2		ns	
th	Hold time after CLK↑	Data high	2		2		2		Τ	
	Floid tille after CENT	Data low	2		2.5		2		ns	

[§] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



[‡] Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second. NOTE 2: ICCZ is measured with OE at 4.5 V and all other inputs grounded.

SN54F534A, SN74F534A OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS SDFS028A – D2932, MARCH 1987 – REVISED OCTOBER 1993

switching characteristics (see Note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 5 V, C_{L} = 50 pF, R_{L} = 500 Ω, T_{A} = 25°C			V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R_L = 500 Ω , T_A = MIN to MAX \dagger				UNIT
				F534A		SN54F	534A	SN74F	534A	
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
fmax			100			60		70		MHz
t _{PLH}	CLK	011/	3	4.5	7	2.5	10.5	2.5	7.5	ns
^t PHL		Any \overline{Q}	3	4.5	7	2.5	11	2.5	7.5	115
^t PZH	ŌĒ	A -	1.2	4.5	7.5	1.2	14	1.2	8.5	
t _{PZL}	OE	Any \overline{Q}	1.2	5	7.5	1.2	10	1.2	8.5	ns
t _{PHZ}	ŌĒ	Any $\overline{\mathbb{Q}}$	1.2	3.5	6.5	1.2	8	1.2	7.5	
t _{PLZ}		Ally Q	1.2	3.5	5.5	1.2	7.5	1.2	6.5	ns

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. NOTE 3: Load circuits and waveforms are shown in Section 1.



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